# 10-Bit, 20MHz Sampling ANALOG-TO-DIGITAL CONVERTER 

## FEATURES

- NO MISSING CODES
- INTERNAL REFERENCE
- LOW DIFFERENTIAL LINEARITY ERROR: 0.2LSB
- LOW POWER: 195mW
- HIGH SNR: 60dB
- WIDEBAND TRACK/HOLD: 65MHz


## APPLICATIONS

- SET-TOP BOXES
- CABLE MODEMS
- VIDEO DIGITIZING
- CCD IMAGING

Camcorders
Copiers
Scanners
Security Cameras

- IF AND BASEBAND DIGITIZATION


## DESCRIPTION

The ADS820 is a low-power, monolithic 10-bit, 20MHz Ana-log-to-Digital (A/D) converter utilizing a small geometry CMOS process. This complete converter includes a 10-bit quantizer with internal track-and-hold, reference, and a power down feature. It operates from a single +5 V power supply and can be configured to accept either differential or single-ended input signals.

The ADS820 employs digital error correction to provide excellent Nyquist differential linearity performance for demanding imaging applications. Its low distortion, high SNR, and high oversampling capability give it the extra margin needed for telecommunications and video applications.
This high performance converter is specified for AC and DC-performance at a 20 MHz sampling rate. The ADS820 is available in an SO-28 package.


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## ABSOLUTE MAXIMUM RATINGS ${ }^{(1)}$



NOTES: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.

## ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## PACKAGE/ORDERING INFORMATION ${ }^{(1)}$

| PRODUCT | PACKAGE-LEAD | PACKAGE <br> DESIGNATOR | SPECIFIED <br> TEMPERATURE <br> RANGE | PACKAGE <br> MARKING | ORDERING <br> NUMBER | TRANSPORT <br> MEDIA, QUANTITY |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS820 <br> $"$ | SO-8 | DW | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | ADS820U | ADS820U | Rails, 28 |
| $" ~$ | $"$ | $"$ | ADS820U/1K | Tape and Reel, 1000 |  |  |

NOTE: (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

## ELECTRICAL CHARACTERISTICS

At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}$, Sampling Rate $=20 \mathrm{MHz}$, with a $50 \%$ duty cycle clock having a 2 ns rise/fall time, unless otherwise noted.

| PARAMETER | CONDITIONS | TEMP | ADS820U |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| Resolution <br> Specified Temperature Range | $\mathrm{T}_{\text {Ambient }}$ |  | -40 | 10 | +85 | $\begin{aligned} & \text { Bits } \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |
| ANALOG INPUT <br> Differential Full-Scale Input Range Common-Mode Voltage Analog Input Bandwidth ( -3 dB ) Small Signal Full Power Input Impedance | $-20 \mathrm{dBFS}{ }^{(1)}$ Input OdB Input | $\begin{aligned} & +25^{\circ} \mathrm{C} \\ & +25^{\circ} \mathrm{C} \end{aligned}$ | +1.25 | $\begin{array}{r} 2.25 \\ 400 \\ 65 \\ 1.25\|\mid 4 \end{array}$ | +3.25 | $\begin{gathered} \mathrm{V} \\ \mathrm{~V} \\ \mathrm{MHz} \\ \mathrm{MHz} \\ \mathrm{M} \Omega \\| \mathrm{pF} \end{gathered}$ |
| DIGITAL INPUT <br> Logic Family <br> Convert Command | Start Conversion |  | TTL/HCT Compatible CMOSFalling Edge |  |  |  |
| ACCURACY ${ }^{(2)}$ <br> Gain Error <br> Gain Tempco <br> Power-Supply Rejection of Gain Input Offset Error <br> Power-Supply Rejection of Offset | $\begin{aligned} & \mathrm{f}_{\mathrm{S}}=2.5 \mathrm{MHz} \\ & \Delta+\mathrm{V}_{\mathrm{S}}= \pm 5 \% \\ & \Delta+\mathrm{V}_{\mathrm{S}}= \pm 5 \% \end{aligned}$ | $\begin{gathered} +25^{\circ} \mathrm{C} \\ \text { Full } \\ \\ +25^{\circ} \mathrm{C} \\ \text { Full } \\ +25^{\circ} \mathrm{C} \end{gathered}$ |  | $\begin{aligned} & \pm 0.6 \\ & \pm 1.0 \\ & \pm 85 \\ & 0.01 \\ & \pm 2.1 \\ & 0.02 \\ & \hline \end{aligned}$ | $\begin{gathered} \pm 1.5 \\ \pm 2.5 \\ \\ 0.1 \\ \pm 3.0 \\ 0.1 \\ \hline \end{gathered}$ | $\begin{gathered} \% \\ \% \\ \text { ppm/ }{ }^{\circ} \mathrm{C} \\ \text { \%FS/\% } \\ \% \\ \% \text { FSR/\% } \end{gathered}$ |
| CONVERSION CHARACTERISTICS <br> Sample Rate <br> Data Latency |  |  | 10k | 6.5 | 20M | Sample/s Convert Cycle |
| DYNAMIC CHARACTERISTICS <br> Differential Linearity Error $\begin{aligned} & f=500 \mathrm{kHz} \\ & f=10 \mathrm{MHz} \end{aligned}$ <br> No Missing Codes Integral Linearity Error at $f=500 \mathrm{kHz}$ Spurious-Free Dynamic Range (SFDR) <br> $\mathrm{f}=500 \mathrm{kHz}$ ( -1 dBFS input) <br> $f=10 \mathrm{MHz}$ ( -1 dBFS input) |  | $+25^{\circ} \mathrm{C}$ Full $+25^{\circ} \mathrm{C}$ Full Full Full $+25^{\circ} \mathrm{C}$ Full $+25^{\circ} \mathrm{C}$ Full | $\begin{aligned} & 67 \\ & 64 \\ & 59 \\ & 57 \\ & \hline \end{aligned}$ | $\begin{gathered} \pm 0.15 \\ \pm 0.15 \\ \pm 0.2 \\ \pm 0.2 \\ \text { Tested } \\ \pm 0.5 \\ \\ 77 \\ 74 \\ 63 \\ 62 \end{gathered}$ | $\begin{aligned} & \pm 1.0 \\ & \pm 1.0 \\ & \pm 1.0 \\ & \pm 1.0 \\ & \pm 2.0 \end{aligned}$ | LSB <br> LSB <br> LSB <br> LSB <br> dBFS dBFS dBFS dBFS |

NOTE: (1) dBFS refers to dB below Full Scale. (2) Percentage accuracies are referred to the internal $\mathrm{A} / \mathrm{D}$ Converter Full-Scale Range of $4 \mathrm{Vp}-\mathrm{p}$. (3) IMD is referred to the larger of the two input signals. If referred to the peak envelope signal ( $\approx 0 \mathrm{~dB}$ ), the intermodulation products will be 7 dB lower. ( 4 ) Based on (SINAD - 1.76)/6.02. (5) No "rollover" of bits.

## ELECTRICAL CHARACTERISTICS (Cont.)

At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}$, Sampling Rate $=20 \mathrm{MHz}$, with a $50 \%$ duty cycle clock having a 2 ns rise/fall time, unless otherwise noted.

| PARAMETER | CONDITIONS | TEMP | ADS820U, E |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX |  |
| $\begin{aligned} & \text { Signal-to-Noise Ratio (SNR) } \\ & f=500 \mathrm{kHz} \text { (-1dBFS input) } \\ & f=10 \mathrm{MHz} \text { (-1dBFS input) } \\ & \text { Signal-to-(Noise + Distortion) (SINAD) } \\ & f=500 \mathrm{kHz} \text { (-1dBFS input) } \\ & \mathrm{f}=10 \mathrm{MHz} \text { (-1dBFS input) } \\ & \text { Differential Gain Error } \\ & \text { Differential Phase Error } \\ & \text { Effective Bits(4) } \\ & \text { Aperture Delay Time } \\ & \text { Aperture Jitter } \\ & \text { Overvoltage Recovery Time }{ }^{(5)} \end{aligned}$ | NTSC or PAL NTSC or PAL $\mathrm{f}_{\mathbb{I N}}=3.58 \mathrm{MHz}$ <br> 1.5x Full-Scale Input | $\begin{aligned} & +25^{\circ} \mathrm{C} \\ & \text { Full } \\ & +25^{\circ} \mathrm{C} \\ & \text { Full } \\ & \\ & +25^{\circ} \mathrm{C} \\ & \text { Full } \\ & +25^{\circ} \mathrm{C} \\ & \text { Full } \\ & +25^{\circ} \mathrm{C} \\ & +25^{\circ} \mathrm{C} \\ & \\ & +25^{\circ} \mathrm{C} \\ & +25^{\circ} \mathrm{C} \\ & +25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{aligned} & 58 \\ & 56 \\ & 58 \\ & 56 \\ & 58 \\ & 55 \\ & 56 \\ & 54 \end{aligned}$ | 60.5 60 60 60 60.5 60 58 57 0.5 0.1 9.5 2 7 2 |  | dB dB dB dB dB dB dB dB $\%$ degrees Bits ns ps rms ns |
| OUTPUTS <br> Logic Family <br> Logic Coding <br> Logic Levels <br> 3-State Enable Time <br> 3-State Disable Time | Logic Selectable <br> Logic LOW, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ <br> Logic HIGH, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | Full Full <br> Full | $\begin{gathered} 0 \\ 2.5 \end{gathered}$ | Compatib <br> $B$ or $B$ <br> 20 <br> 2 | $\begin{aligned} & S \\ & \\ & \\ & 0.4 \\ & +V_{S} \\ & 40 \\ & 10 \end{aligned}$ | $\begin{gathered} \mathrm{V} \\ \mathrm{~V} \\ \mathrm{~V} \\ \mathrm{~ns} \\ \mathrm{~ns} \end{gathered}$ |
| POWER-SUPPLY REQUIREMENTS <br> Supply Voltage: $+\mathrm{V}_{\mathrm{S}}$ <br> Supply Current: +Is <br> Power Consumption <br> Thermal Resistance, $\theta_{\mathrm{JA}}$ SO-28 | Operating <br> Operating <br> Operating <br> Operating <br> Operating | $\begin{gathered} \text { Full } \\ +25^{\circ} \mathrm{C} \\ \text { Full } \\ +25^{\circ} \mathrm{C} \\ \text { Full } \end{gathered}$ | +4.75 | $\begin{gathered} +5 \\ 39 \\ 40 \\ 195 \\ 200 \\ 75 \end{gathered}$ | $\begin{gathered} +5.25 \\ 47 \\ 55 \\ 235 \\ 275 \end{gathered}$ | $\begin{gathered} \mathrm{V} \\ \mathrm{~mA} \\ \mathrm{~mA} \\ \mathrm{~mW} \\ \mathrm{~mW} \\ \\ \\ \hline{ }^{\circ} \mathrm{C} / \mathrm{W} \end{gathered}$ |

NOTE: (1) dBFS refers to dB below Full Scale. (2) Percentage accuracies are referred to the internal $\mathrm{A} / \mathrm{D}$ Converter Full-Scale Range of $4 \mathrm{Vp}-\mathrm{p}$. (3) IMD is referred to the larger of the two input signals. If referred to the peak envelope signal ( $\approx 0 \mathrm{~dB}$ ), the intermodulation products will be 7 dB lower. ( 4 ) Based on (SINAD - 1.76)/6.02. (5) No "rollover" of bits.

PIN CONFIGURATION

\begin{tabular}{|c|c|c|c|c|c|}
\hline Top View \& \& \& \& \& SO <br>
\hline GND \& 1 \& \multirow[t]{14}{*}{O

ADS820} \& 28 \& GND \& <br>
\hline Bit 1(MSB) \& 2 \& \& 27 \& $\overline{\mathrm{IN}}$ \& <br>
\hline Bit 2 \& 3 \& \& 26 \& IN \& <br>
\hline Bit 3 \& 4 \& \& 25 \& GND \& <br>
\hline Bit 4 \& 5 \& \& 24 \& $+\mathrm{V}_{\text {S }}$ \& <br>
\hline Bit 5 \& 6 \& \& 23 \& REFT \& <br>
\hline Bit 6 \& 7 \& \& 22 \& CM \& <br>
\hline Bit 7 \& 8 \& \& 21 \& REFB \& <br>
\hline Bit 8 \& 9 \& \& 20 \& $+V_{S}$ \& <br>
\hline Bit 9 \& 10 \& \& 19 \& MSBI \& <br>
\hline Bit 10 (LSB) \& 11 \& \& 18 \& OE \& <br>
\hline DNC \& 12 \& \& 17 \& $+\mathrm{V}_{\text {S }}$ \& <br>
\hline DNC \& 13 \& \& 16 \& CLK \& <br>
\hline \multirow[t]{2}{*}{GND} \& 14 \& \& 15 \& $+\mathrm{V}_{\text {S }}$ \& <br>
\hline \& \& DNC: Do Not Co \& \& \& <br>
\hline
\end{tabular}

PIN DESCRIPTIONS

| PIN | DESIGNATOR | DESCRIPTION |
| :---: | :---: | :---: |
| 1 | GND | Ground |
| 2 | B1 | Bit 1, Most Significant Bit (MSB) |
| 3 | B2 | Bit 2 |
| 4 | B3 | Bit 3 |
| 5 | B4 | Bit 4 |
| 6 | B5 | Bit 5 |
| 7 | B6 | Bit 6 |
| 8 | B7 | Bit 7 |
| 9 | B8 | Bit 8 |
| 10 | B9 | Bit 9 |
| 11 | B10 | Bit 10, Least Significant Bit (LSB) |
| 12 | DNC | Do not connect. |
| 13 | DNC | Do not connect. |
| 14 | GND | Ground |
| 15 | $+\mathrm{V}_{\text {S }}$ | +5V Power Supply |
| 16 | CLK | Convert Clock Input, 50\% Duty Cycle |
| 17 | $+\mathrm{V}_{\text {S }}$ | +5V Power Supply |
| 18 | $\overline{\mathrm{OE}}$ | HIGH: High Impedance State. LOW or Floating: Normal Operation. Internal pull-down resistor. |
| 19 | MSBI | Most Significant Bit Inversion, HIGH: MSB inverted for complementary output. LOW or Floating: Straight output. Internal pull-down resistor. |
| 20 | $+\mathrm{V}_{\text {S }}$ | +5V Power Supply |
| 21 | REFB | Bottom Reference Bypass. For external bypassing of internal +1.25 V reference. |
| 22 | CM | Common-Mode Voltage. It is derived by (REFT + REFB)/2. |
| 23 | REFT | Top Reference Bypass. For external bypassing of internal +3.25 V reference. |
| 24 | $+\mathrm{V}_{\text {S }}$ | +5V Power Supply |
| 25 | GND | Ground |
| 26 | IN | Input |
| 27 | $\overline{\mathrm{N}}$ | Complementary Input |
| 28 | GND | Ground |

TIMING DIAGRAM


## TYPICAL CHARACTERISTICS

At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}$, Sampling Rate $=20 \mathrm{MHz}$, with a $50 \%$ duty cycle clock having a 2 ns rise/fall time, unless otherwise noted.







## TYPICAL CHARACTERISTICS (Cont.)

At $T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}$, Sampling Rate $=20 \mathrm{MHz}$, with a $50 \%$ duty cycle clock having a 2 ns rise/fall time, unless otherwise noted.


## TYPICAL CHARACTERISTICS (Cont.)

At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}$, Sampling Rate $=20 \mathrm{MHz}$, with a $50 \%$ duty cycle clock having a 2 ns rise/fall time, unless otherwise noted.







## TYPICAL CHARACTERISTICS (Cont.)

At $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}$, Sampling Rate $=20 \mathrm{MHz}$, with a $50 \%$ duty cycle clock having a 2 ns rise/fall time, unless otherwise noted.





## THEORY OF OPERATION

The ADS820 is a high-speed, sampling A/D converter with pipelining. It uses a fully differential architecture and digital error correction to ensure 10-bit resolution. The differential track-and-hold circuit is shown in Figure 1. The switches are controlled by an internal clock that has a non-overlapping, two-phase signal, $\phi 1$ and $\phi 2$. At the sampling time the input signal is sampled on the bottom plates of the input capacitors. In the next clock phase, $\phi 2$, the bottom plates of the input capacitors are connected together and the feedback capacitors are switched to the op amp output. At this time, the charge redistributes between $\mathrm{C}_{\boldsymbol{I}}$ and $\mathrm{C}_{\mathrm{H}}$, completing one track-and-hold cycle. The differential output is a held DC representation of the analog input at the sample time. The track-and-hold circuit can also convert a single-ended input signal into a fully differential signal for the quantizer.
The pipelined quantizer architecture has nine stages with each stage containing a 2-bit quantizer and a 2-bit Digital-toAnalog Converter (DAC), as shown in Figure 2. Each 2-bit quantizer stage converts on the edge of the sub-clock, which is twice the frequency of the externally applied clock. The output of each quantizer is fed into its own delay line to


FIGURE 1. Input Track-and-Hold Configuration with Timing Signals.


FIGURE 2. Pipeline A/D Converter Architecture.
time-align it with the data created from the following quantizer stages. This aligned data is fed into a digital error correction circuit that can adjust the output data based on the information found on the redundant bits. This technique gives the ADS820 excellent differential linearity and ensures no missing codes at the 10-bit level.
There is a 6.5 clock cycle data latency from the start convert signal to the valid output data. The output data is available in Straight Offset Binary (SOB) or Binary Two's Complement (BTC) format.

## THE ANALOG INPUT AND INTERNAL REFERENCE

The analog input of the ADS820 can be configured in various ways and driven with different circuits, depending on the nature of the signal and the level of performance desired. The ADS820 has an internal reference that sets the full-scale input range of the $A / D$ converter. The differential input range has each input centered around the common-mode of +2.25 V , with each of the two inputs having a full-scale range of +1.25 V to +3.25 V . Since each input is $2 \mathrm{Vp}-\mathrm{p}$ and $180^{\circ}$ out-of-phase with the other, a 4 V differential input signal to the quantizer results. The positive full-scale reference (REFT) and the negative full-scale reference (REFB) are brought out for external bypassing, as shown in Figure 3. In addition, the common-mode (CM) voltage may be used as a reference to provide the appropriate offset for the driving circuitry. However, care must be taken not to appreciably load this reference node. For more information regarding external references, single-ended inputs, and ADS820 drive circuits, refer to the applications section.


FIGURE 3. Internal Reference Structure.

## CLOCK REQUIREMENTS

The CLK pin accepts a CMOS level clock input. The rising and falling edge of the externally applied convert command clock controls the various interstage conversions in the pipeline. Therefore, the duty cycle of the clock should be held at $50 \%$ with low jitter and fast rise and fall times of 2 ns or less. This is especially important when digitizing a highfrequency input and operating at the maximum sample rate. Deviation from a 50\% duty cycle will effectively shorten some of the interstage settling times, thus degrading the SNR and DNL performance.

## DIGITAL OUTPUT DATA

The 10 -bit output data is provided at CMOS logic levels. The standard output coding is Straight Offset Binary where a fullscale input signal corresponds to all " 1 's" at the output. This condition is met with pin 19 LOW or Floating due to an internal pull-down resistor. By applying a high voltage to this pin, a BTC output will be provided where the most significant bit is inverted. The digital outputs of the ADS820 can be set to a high impedance state by driving $\overline{\mathrm{OE}}$ (pin 18) with a logic HIGH. Normal operation is achieved with pin 18 LOW or Floating due to internal pull-down resistors. This function is provided for testability purposes and is not meant to drive digital buses directly or be dynamically changed during the conversion process.

|  | OUTPUT CODE |  |
| :--- | :---: | :---: |
|  | SOB | BTC |
| DIFFERENTIAL INPUT(1) | PIN 19 | PIN 19 |
|  | FLOATING or LOW | HIGH |
| +FS $($ IN $=+3.25 \mathrm{~V}, \overline{\mathrm{IN}}=+1.25 \mathrm{~V})$ | 1111111111 | 0111111111 |
| +FS -1LSB | 1111111111 | 011111111 |
| +FS -2LSB | 1111111110 | 0111111110 |
| +3/4 Full Scale | 1110000000 | 0110000000 |
| +1/2 Full Scale | 1100000000 | 0100000000 |
| +1/4 Full Scale | 1010000000 | 0010000000 |
| +1LSB | 1000000001 | 000000001 |
| Bipolar Zero (IN $=\overline{\mathbb{I N}}=+2.25 \mathrm{~V})$ | 1000000000 | 0000000000 |
| -1LSB | 011111111 | 111111111 |
| -1/4 Full Scale | 0110000000 | 1110000000 |
| -1/2 Full Scale | 0100000000 | 1100000000 |
| -3/4 Full Scale | 0010000000 | 1010000000 |
| -FS +1LSB | 0000000001 | 1000000001 |
| -FS (IN $=+1.25 \mathrm{~V}, \overline{\text { IN }}=+3.25 \mathrm{~V})$ | 0000000000 | 1000000000 |
| NOTE: (1) In the single-ended input mode, + FS $=+4.25 \mathrm{~V}$ and - FS $=+0.25 \mathrm{~V}$ |  |  |

TABLE I. Coding Table for the ADS820.

## APPLICATIONS

## DRIVING THE ADS820

The ADS820 has a differential input with a common mode of +2.25 V . For AC-coupled applications, the simplest way to create this differential input is to drive the primary winding of a transformer with a single-ended input. A differential output is created on the secondary if the center tap is tied to the (CM) voltage of +2.25 V , as per Figure 4. This transformercoupled input arrangement provides good high frequency


FIGURE 4. AC-Coupled Single-Ended to Differential Drive Circuit Using a Transformer.

AC performance. It is important to select a transformer that gives low distortion and does not exhibit core saturation at full-scale voltage levels. Since the transformer does not appreciably load the ladder, there is no need to buffer the CM output in this instance. In general, it is advisable to keep the current draw from the CM output pin below $0.5 \mu \mathrm{~A}$ to avoid nonlinearity in the internal reference ladder. A FET input operational amplifier, such as the OPA130, can provide a buffered reference for driving external circuitry. The analog IN and $\overline{\mathrm{IN}}$ inputs should be bypassed with 22 pF capacitors to minimize track-and-hold glitches and to improve high-input frequency performance.
Figure 5 illustrates another possible low-cost interface circuit that utilizes resistors and capacitors in place of a transformer. Depending on the signal bandwidth, the component values should be carefully selected in order to maintain the performance outlined in the data sheet. The input capacitors, $\mathrm{C}_{\mathbb{N}^{N}}$, and the input resistors, $\mathrm{R}_{\mathrm{IN}}$, create a high-pass filter with the lower corner frequency at $f_{C}=1 /\left(2 \pi \mathrm{R}_{\mathrm{IN}} \mathrm{C}_{\mathrm{IN}}\right)$. The corner frequency can be reduced by either increasing the value of $\mathrm{R}_{\mathbb{I N}}$ or $\mathrm{C}_{\mathbb{I N}}$. If the circuit operates with a $50 \Omega$ or $75 \Omega$ impedance level, the resistors are fixed and only the value of the capacitor can be increased. Usually AC-coupling capacitors are electrolytic or tantalum capacitors with values of $1 \mu \mathrm{~F}$ or higher. It should be noted that these large capacitors become inductive with increased input frequency, which could lead to signal amplitude errors or oscillation. To maintain a low accoupling impedance throughout the signal band, a small value (e.g. $1 \mu \mathrm{~F}$ ) ceramic capacitor could be added in parallel with the polarized capacitor.
Capacitors $\mathrm{C}_{\mathrm{SH} 1}$ and $\mathrm{C}_{\mathrm{SH} 2}$ are used to minimize current glitches resulting from the switching in the input track and hold stage and to improve signal-to-noise performance. These capacitors can also be used to establish a low-pass filter and effectively reduce the noise bandwidth. In order to create a real pole, resistors $R_{\text {SER1 }}$ and $R_{\text {SER2 }}$ were added in series with
each input. The cutoff frequency of the filter is determined by $f_{C}=1 /\left(2 \pi R_{S E R} \cdot\left(C_{S H}+C_{A D C}\right)\right)$ where $R_{S E R}$ is the resistor in series with the input, $\mathrm{C}_{S H}$ is the external capacitor from the input to ground, and $\mathrm{C}_{\mathrm{ADC}}$ is the internal input capacitance of the $A / D$ converter (typically 4 pF ).
Resistors $R_{1}$ and $R_{2}$ are used to derive the necessary common-mode voltage from the buffered top and bottom references. The total load of the resistor string should be selected so that the current does not exceed 1 mA . Although the circuit in Figure 5 uses two resistors of equal value so that the common-mode voltage is centered between the top and bottom reference $(+2.25 \mathrm{~V})$, it is not necessary to do so. In all cases the center point, $\mathrm{V}_{\mathrm{CM}}$, should be bypassed to ground in order to provide a low-impedance ac ground.

If the signal needs to be DC-coupled to the input of the ADS820, an operational amplifier input circuit is required. In the differential input mode, any single-ended signal must be modified to create a differential signal. This can be accomplished by using two operational amplifiers; one in the noninverting mode for the input and the other amplifier in the inverting mode for the complementary input. The low distortion circuit in Figure 6 will provide the necessary input shifting required for signals centered around ground. It also employs a diode for output level shifting to ensrue a low distortion +3.25 V output swing. Another DC-coupled circuit is shown in Figure 7. Other amplifiers can be used in place of the OPA860s if the lowest distortion is not necessary. If output level shifting circuits are not used, care must be taken to select operational amplifiers that give the necessary performance when swinging to +3.25 V with a $\pm 5 \mathrm{~V}$ supply operational amplifier. The OPA620 and OPA621, or the lower power OPA820 can be used in place of the OPA860s in Figure 6. In that configuration, the OPA820 will typically swing to within 100 mV of positive full scale.


FIGURE 5. AC-Coupled Differential Input Circuit.


FIGURE 6. A Low Distortion DC-Coupled, Single-Ended to Differential Input Driver Circuit.


NOTE: Power supplies and bypassing not shown. The measured SNR performance with 12.5 MHz input signal is 57 dB with this driver circuit.

FIGURE 7. A Wideband DC-Coupled, Single-Ended to Differential Input Driver Circuit.

The ADS820 can also be configured with a single-ended input full-scale range of +0.25 V to +4.25 V by tying the complementary input to the common-mode reference voltage, as shown in Figure 8. This configuration will result in increased evenorder harmonics, especially at higher input frequencies. However, this trade-off may be quite acceptable for time-domain applications. The driving amplifier must give adequate performance with $\mathrm{a}+0.25 \mathrm{~V}$ to +4.25 V output swing in this case.


Full Scale $=+0.25 \mathrm{~V}$ to +4.25 V with internal references.
FIGURE 8. Single-Ended Input Connection.

## EXTERNAL REFERENCES AND

 ADJUSTMENT OF FULL-SCALE RANGEThe internal reference buffers are limited to approximately 1 mA of output current. As a result, these internal +1.25 V and +3.25 V references may be overridden by external references that have at least 18 mA (at room temperature) of output drive capability. In this instance, the common-mode voltage will be
set halfway between the two references. This feature can be used to adjust the gain error, improve gain drift, or to change the full-scale input range of the ADS820. Changing the fullscale range to a lower value has the benefit of easing the swing requirements of external input amplifiers. The external references can vary as long as the value of the external top reference $\left(\mathrm{REFT}_{E X T}\right)$ is less than or equal to +3.4 V , the value of the external bottom reference $\left(\right.$ REFB $\left._{E X T}\right)$ is greater than or equal to +1.1 V , and the difference between the external references are greater than or equal to 800 mV .
For the differential configuration, the full-scale input range will be set to the external reference values that are selected. For the single-ended mode, the input range is $2 \cdot\left(R E F T_{\text {EXT }}-R E F B_{E X T}\right)$, with the common-mode being centered at $\left(\right.$ REFT $_{\text {EXT }}+$ REFB $\left._{\text {EXT }}\right) / 2$. Refer to the typical performance curves for expected performance versus fullscale input range.
The circuit in Figure 9 works completely on a single +5 V supply. As a reference element, it uses micro-power reference REF1004-2.5, which is set to a quiescent current of 0.1 mA . Amplifier $\mathrm{A}_{2}$ is configured as a follower to buffer the +1.25 V generated from the resistor divider. To provide the necessary current drive, a pull-down resistor, $\mathrm{R}_{\mathrm{P}}$, is added.
Amplifier $\mathrm{A}_{1}$ is configured as an adjustable gain stage, with a range of approximately 1 to 1.32 . The pull-up resistor again relieves the op amp from providing the full current drive. The value of the pull-up and pull-down resistors is not critical and can be varied to optimize power consumption. The need for pull-up/down resistors depends only on the drive capability of the selected drive amplifiers and thus can be omitted.


NOTE: (1) Use parts alternatively for adjustment capability.

FIGURE 9. Optional External Reference to Set the Full-Scale Range Utilizing a Dual, Single-Supply Op Amp.

## PC-BOARD LAYOUT AND BYPASSING

A well-designed, clean PC-board layout will assure proper operation and clean spectral response. Proper grounding and bypassing, short lead lengths, and the use of ground planes are particularly important for high frequency circuits. Multilayer PC boards are recommended for best performance but if carefully designed, a two-sided pc board with large, heavy ground planes can give excellent results. It is recommended that the analog and digital ground pins of the ADS820 be connected directly to the analog ground plane. In our experience, this gives the most consistent results. The A/D converter power-supply commons should be tied together at the analog ground plane. Power supplies should be bypassed with $0.1 \mu \mathrm{~F}$ ceramic capacitors as close to the pin as possible.

## DYNAMIC PERFORMANCE TESTING

The ADS820 is a high-performance converter and careful attention to test techniques is necessary to achieve accurate results. Highly accurate phase-locked signal sources allow high-resolution FFT measurements to be made without using data windowing functions. A low jitter signal generator such as the HP8644A for the test signal, phase-locked with a low jitter HP8022A pulse generator for the A/D converter clock,
gives excellent results. Low-pass filtering (or bandpass filtering) of test signals is absolutely necessary to test the low distortion of the ADS820. Using a signal amplitude slightly lower than full scale will allow a small amount of "headroom" so that noise or DC-offset voltage will not overrange the A/D converter and cause clipping on signal peaks.

## DYNAMIC PERFORMANCE DEFINITIONS

1. Signal-to-Noise-and-Distortion Ratio (SINAD):
$10 \log \frac{\text { Sinewave Signal Power }}{\text { Noise + Harmonic Power (first } 15 \text { harmonics) }}$
2. Signal-to-Noise Ratio (SNR):
$10 \log \frac{\text { Sinewave Signal Power }}{\text { Noise Power }}$
3. Intermodulation Distortion (IMD):
$10 \log \frac{\text { Highest IMD Pr oduct Power (to 5th order) }}{\text { Sinewave Signal Power }}$
IMD is referenced to the larger of the test signals $f_{1}$ or $f_{2}$. Five "bins" either side of peak are used for calculation of fundamental and harmonic power. The " 0 " frequency bin (DC) is not included in these calculations, as it is of little importance in dynamic signal processing applications.


FIGURE 10. ADS820 Interface Schematic with AC-Coupling and External Buffers.

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead/Ball Finish <br> (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS820U | ACTIVE | SOIC | DW | 28 | 20 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | ADS820U | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the $<=1000 \mathrm{ppm}$ threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a " $\sim$ " will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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DW (R-PDSO-G28)
PLASTIC SMALL OUTLINE


NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed $0.006(0,15)$.
D. Falls within JEDEC MS-013 variation AE.
DW (R-PDSO-G28)


NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Refer to IPC7351 for alternate board design.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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